Small / Slim Object Detection Area Sensor



Cross-beam scanning system to detect slim objects

Selection Guide Wafer Detection M-DW1 HD-T1 Liquid Leak Detection EX-F70 / EX-F60 Liquid Level Detection EX-F1 Color Mark Detection LX-100 FZ-10 Small / Slim Metal-sheet Double-feed Detection GD Other Products

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LASER MARKERS

Letter or visiting card detectable!

Slim objects can be detected by using the cross-beam scanning system.

Wide area

Though being very slim, it realizes a wide sensing area of 1 m 3.281 ft length and 100 mm 3.937 in width. It is most suitable for object detection on a wide assembly line, or for detecting the dropping of, or incursion by, small objects whose travel path is uncertain.



Emitting and receiving element pitch: 10 mm 0.394 in

A minimum sensing object size of ø13.5 mm ø 0.531 in is realized by using an emitting and receiving element pitch of 10 mm 0.394 in.



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Just 10 mm 0.394 in thick

It is extremely slim, being just 10 mm 0.394 in thick. Further, it can be mounted in a narrow space since you can select from two cable orientation directions.



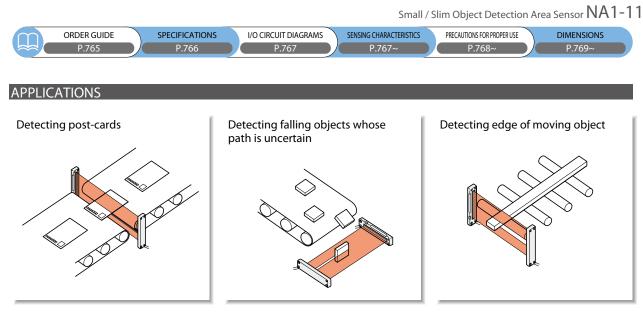
It is possible to select from two cable orientation directions.

Globally useable

It conforms to the EMC Directive and has UL Recognition. Moreover, PNP output type, which is much in demand in Europe, is also available.



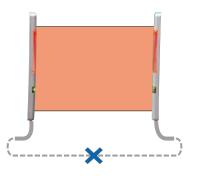






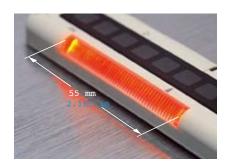
No synchronization wire

Wiring is saved and made simple as no synchronization wire is required between the emitter and the receiver.



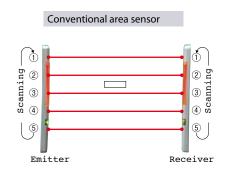
Clearly visible indicator

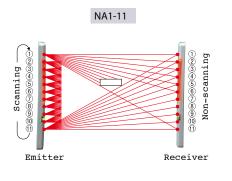
A clearly visible large indicator, having a 55 mm 2.165 in width, is incorporated on both the emitter and the receiver. Further, if the sensing output is directly connected to the large indicator input, the indicator can be conveniently used as a large operation indicator. Moreover, its operation can be selected as lighting or blinking.



Cross-beam Scanning System

In a conventional area sensor, slim objects cannot be detected since the emitting and the receiving elements are scanned, synchronously, as a set. In contrast, in NA1-11, only the elements to Of the emitter are scanned to obtain emission. The elements of the receiver are not scanned, so that when element of the emitter emits light, all the elements of the receiver receive light. Hence, even if there is one element on the receiver which does not receive light, it results in light interrupted operation. With this technique, detection of slim objects is possible.





SENSOR OPTIONS WIRE-

SAVING

SYSTEMS

MEASURE-MENT SENSORS

STATIC CONTROL DEVICES

LASER MARKERS

Selection Guide

Wafer Detection M-DW1

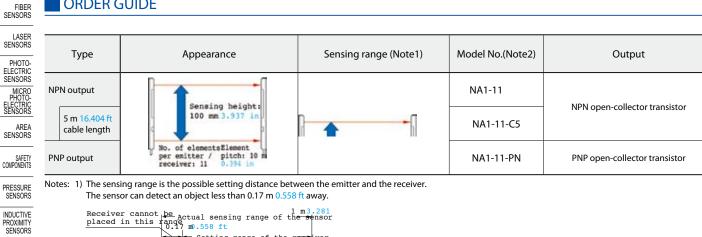
HD-T1 Liquid Leak Detection

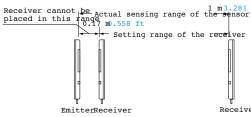
EX-F70 / EX-F60 Liquid Level Detection

EX-F1 Color Mark Detection LX-100

> FZ-10 Small / Slim

Metal-sheet Double-feed Detection GD Other Products **ORDER GUIDE**





2) The model No. with suffix "P" shown on the label affixed to the product is the emitter, "D" shown on the label is the receiver. (e.g.) Emitter of NA1-11: NA1-11P, Receiver of NA1-11: NA1-11D

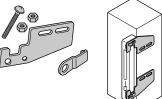
OPTIONS

_	Designation	Model No.	Description	Sensor mounti • MS-NA1-1
	Sensor mounting bracket	MS-NA1-1	Four bracket set Four M4 (length 15 mm 0.591 in) screws with washers, eight nuts, four hooks, four spacers and eight M4 (length 18 mm 0.709 in) screws with washers are attached. (Spacers are not attached with MS-NA1-1.)	00

ting bracket







M4 screws with washers, nuts, hooks and spacers are attached.

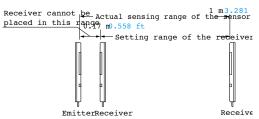


SPECIFICATIONS

\checkmark	Туре	NPN output	PNP output	
ltem	Model No.	NA1-11	NA1-11-PN	
Sensing height		100 mm 3.937 in		
Sensing range (Note 2)		0.17 to 1 m 0.558 to 3.281 ft		
Element pitch		10 mm 0.394 in		
Number of emitting / receiving elements		11 Nos. each on the emitter and the receiver, respectively		
Sensing object		ø13.5 mm ø0.531 in or more opaque object (Note 3)		
Supply voltage		12 to 24 V DC ± 10 % Ripple P-P 10 % or less		
Current consumption		Emitter: 80 mA or less, Receiver: 100 mA or less		
Output		NPN open-collector transistor Maximum sink current: 100 mA Applied voltage: 30 V DC or less (between output and 0 V) Residual voltage: 1 V or less (at 100 mA sink current) 0.4 V or less (at 16 mA sink current)	PNP open-collector transistor Maximum source current: 100 mA Applied voltage: 30 V DC or less (between output and +V) Residual voltage: 1 V or less (at 100 mA source current) 0.4 V or less (at 16 mA source current)	
	Utilization category	DC-12 or DC-13		
	Output operation	ON or OFF when beam channel is interrupted, selectable by operation mode switch		
	Short-circuit protection	Incorporated		
Resp	onse time	In Dark state: 5 ms or less, In Light state: 10 ms or less		
ors	Emitter	Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED (lights up or blinks when the large indicator input is Low, lighting pattern is selected by operation mode switch	Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED (lights up or blinks when the large indicator input is High, lighting pattern is selected by operation mode switch	
Indicators	Receiver	Operation indicator: Orange LED (lights up when the output is ON) Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED (lights up or blinks when the large indicator input is Low, lighting pattern is selected by operation mode switch	Operation indicator: Orange LED (lights up when the output is ON) Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED (lights up or blinks when the large indicator input is High, lighting pattern is selected by operation mode switch	
	Pollution degree	3 (Industrial environment)		
	Protection	IP62 (IEC) (Refer to p.984 for details of standards)		
ce	Ambient temperature	–10 to 55 °C +14 to +131 °F (No dew condensation or icing allowed), Storage: –20 to +70 °C –4 to +158 °F		
istan	Ambient humidity	35 to 85 % RH, Storage: 35 to 85 % RH		
Environmental resistance	Ambient illuminance	Incandescent light: 3,000 ℓ x at the light-receiving face		
nent	EMC	EN 60947-5-2		
ironr	Voltage withstandability	1,000 V AC for one min. between all supply terminals connected together and enclosure		
Env	Insulation resistance	$20 \text{ M}\Omega$, or more, with 250 V DC megger between all supply terminals connected together and enclosure		
	Vibration resistance	10 to 150 Hz frequency, 1.5 mm 0.059 in amplitude in X, Y and Z directions for two hours each		
	Shock resistance	500 m/s ² acceleration (50 G approx.) in X, Y and Z directions for three times each		
Emit	ting element	Infrared LED (Peak emission wavelength: 880nm 0.035mil, cross-beam scanning system)		
Mate	rial	Enclosure: Heat-resistant ABS, Lens: Acrylic, Indicator cover: Acrylic		
Cable		0.3 mm ² 4-core (emitter: 3-core) oil resistant cabtyre cable, 2 m 6.562 ft long		
Cable extension		Extension up to total 100 m 328.084 ft is possible, for both emitter and receiver, with 0.3 mm ² , or more, cable.		
Weight		Net weight: Emitter 80 g approx., Receiver 85 g approx, Gross Weight: 210 g approx.		
		ditions have not been specified precisely, the conditions used were an ambient temperature of ± 23 °C ± 73.4 °E		

Notes: 1) Where measurement conditions have not been specified precisely, the conditions used were an ambient temperature of +23 °C +73.4 °F.

2) The sensing range is the possible setting distance between the emitter and the receiver. The sensor can detect an object less than 0.17 m 0.558 ft away.



3) Although this product can detect slim objects by using the cross-beam scanning system, the size of the slim object which can be stably detected differs with the setting distance. When this sensor is used to detect slim objects, make sure to confirm stable detection using the actual objects.

FIBER SENSORS

LASER SENSORS

PHOTO-ELECTRIC SENSORS

MICRO PHOTO-ELECTRIC SENSORS

AREA SENSORS

SAFETY COMPONENTS

PRESSURE

INDUCTIVE PROXIMITY SENSORS

SENSOR OPTIONS

WIRE-

SAVING

SYSTEMS

MEASURE-

MENT SENSORS

STATIC CONTROL DEVICES

LASER MARKERS

Selection Guide

Detection

M-DW1

HD-T1

Liquid Leak Detection

EX-F70 / EX-F60

Liquid Level Detection

EX-F1

Color Mark Detection

LX-100

FZ-10

Metal-sheet Double-feed Detection

Other Products

GD

Wafer

NA1-11

I/O CIRCUIT AND WIRING DIAGRAMS

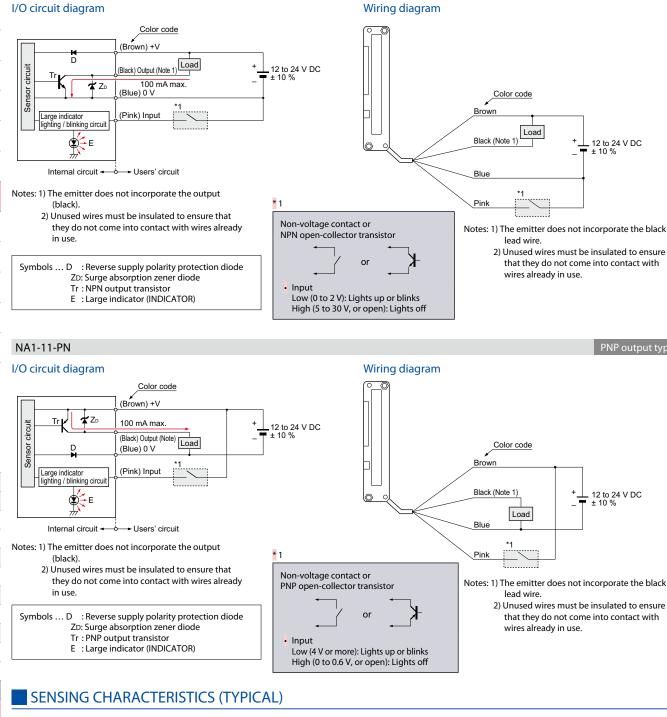


. 12 to 24 V DC ± 10 %

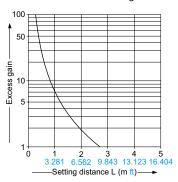
PNP output type

12 to 24 V DC ± 10 %

mailbox@sentronic.com www.sentronic.com

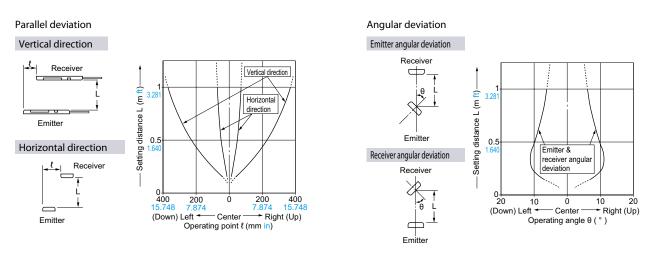


Correlation between setting distance and excess gain

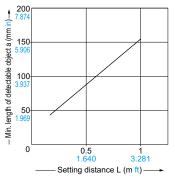


SUNX

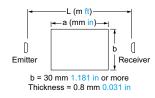
SENSING CHARACTERISTICS (TYPICAL)



Correlation between setting distance and minimum length of detectable object



The minimum length of the detectable object, which lies in a plane perpendicular to the sensor front surface, varies with the setting distance, as shown in the left graph. However, note that the minimum length of the detectable object also varies with the object thickness.



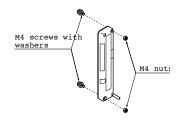
* The sensing object is considered to be placed at the center of the sensing area.

PRECAUTIONS FOR PROPER USE

- Never use this product as a sensing device for personnel protection.
- For sensing devices to be used as safety devices for press machines or for personnel protection, use products which meet laws and standards, such as OSHA, ANSI or IEC etc., for personnel protection applicable in each region or country.
- If this product is used as a sensing device for personnel protection, death or serious body injury could result.
- For a product which meets safety standards, use the following products.
 Type 4: SF4B series (P.481~)
 Type 2: SF2B series (P.515~)

Mounting

 Use M4 screws with washers and M4 nuts. The tightening torque should be 0.5 N·m or less.
 (Please arrange the screws and nuts separately.)



Selection of large indicator operation

Refer to p.986~ for general precautions.

Lighting / Blinking is selected by the operation mode switch on the emitter and the receiver.

Operation of	Operation mode switch			
large indicator	Emitter	Receiver		
Lighting	LIGHT BLINK	LIGHT BLINK		
Blinking	LIGHT 🔳 BLINK	LIGHT BLINK		

Selection of output operation

• The output operation mode is selected by the operation mode switch on the receiver.

The switches must be set with the power supply off. The operation mode does not change if the switch setting is changed with the power supplied.

Operation mode switch (Receiver)	Output operation	Operation indicator (Orange)
D-ON D/ON L/ON	ON in Dark state	Lights up when the output is ON
L-ON D/ON L/ON	OFF in Dark state	Lights up when the output is ON

Note: LIGHT / BLINK switch is not related to the output operation selection.

SENSOR OPTIONS

WIRE-SAVING SYSTEMS MEASURE-

MENT SENSORS

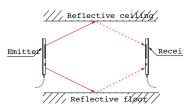
STATIC CONTROL DEVICES

LASER MARKERS

PRECAUTIONS FOR PROPER USE

Others

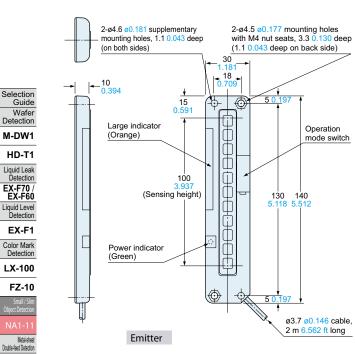
- Do not use during the initial transient time (0.5 sec.) after the power supply is switched on.
- Although this sensor can detect slim objects by using the cross-beam scanning system, the size of the slim object which can be stably detected differs with the setting distance. Hence, when the sensor is used to detect slim objects, make sure to confirm stable detection using the actual objects.
- In case of this sensor, light from the emitter spreads above and below the sensor. Hence, take care that if there is a reflective object above or below the sensor it will affect the sensing.

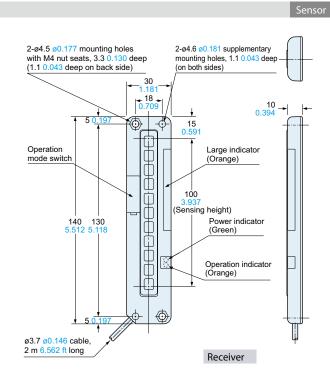


* Refer to "Parallel deviation" on p.768.

DIMENSIONS (Unit: mm in)

NA1-11 NA1-11-PN



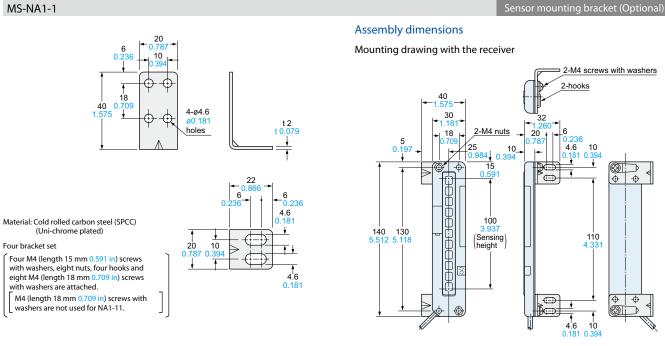


Refer to p.986~ for general precautions.

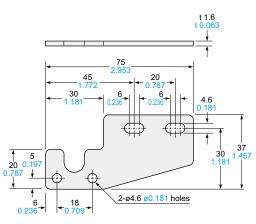
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GD Other Products

DIMENSIONS (Unit: mm in)



MS-NA2-1



Material: Cold rolled carbon steel (SPCC) (Uni-chrome plated)

Four bracket set

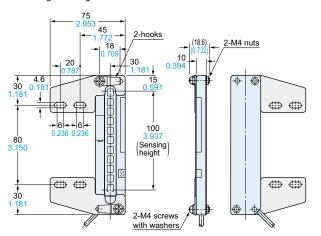
Four M4 (length 15 mm 0.591 in) screws with washers,

eight nuts, four hooks, four spacers and eight M4 (length 18 mm 0.709 in) screws with washers are attached.

Sensor mounting bracket (Optional)

Assembly dimensions

Mounting drawing with the receiver



mailbox@sentronic.com www.sentronic.com